



Hex Half-bridge Driver with Serial Input Control

DATASHEET

Features

- Six half-bridge outputs formed by six high-side and six low-side drivers
- Capable of switching all kinds of loads (such as DC motors, bulbs, resistors, capacitors and inductors)
- R_{DSon} typically 1.0 Ω at 25°C, maximum 1.8 Ω at 150°C
- Up to 950-mA output current
- Very low total quiescent current I_S < 2μA in standby mode
- Outputs short-circuit protected
- Overtemperature prewarning and protection
- Undervoltage protection
- Various diagnosis functions such as shorted output, open load, overtemperature and power supply fail
- Serial data interface
- Operation voltage up to 40V
- Daisy chaining possible
- Serial interface 5V compatible, up to 2MHz clock frequency
- QFN24 5mm x 5mm power package

1. Description

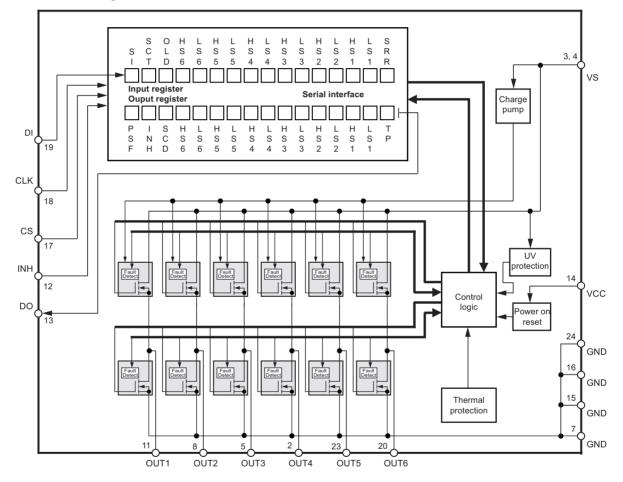
The Atmel® ATA6838C is a fully protected hex half-bridge driver designed in Smart Power SOI technology, used to control up to six different loads by a microcontroller in automotive and industrial applications.

Each of the six high-side and six low-side drivers is capable of driving currents up to 950mA. The drivers are internally connected to form six half-bridges and can be controlled separately from a standard serial data interface. Therefore, all kinds of loads, such as bulbs, resistors, capacitors and inductors, can be combined. The IC especially supports the application of H-bridges to drive DC motors.

Protection is guaranteed in terms of short-circuit conditions, overtemperature and undervoltage. Various diagnosis functions and a very low guiescent current in standby mode make a wide range of applications possible.

Automotive qualification referring to conducted interferences, EMC protection and ESD protection gives added value and enhanced quality for the exacting requirements of automotive applications.

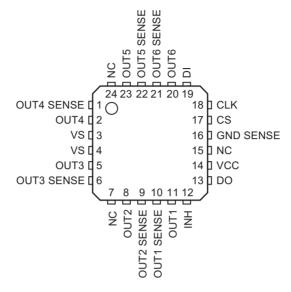
Figure 1-1. Block Diagram QFN24



2. Pin Configuration

2.1 QFN24

Figure 2-1. Pinning QFN 24, 5×5 , 0.65mm Pitch



Note: YWW Date code (Y = Year above 2000, WW = week number)

ATAxyz Product name ZZZZZ Wafer lot number

AL Assembly sub-lot number

Table 2-1. Pin Description QFN24

| Pin | Symbol | Function |
|-----|---------------|---|
| 1 | OUT4 SENSE | Only for testability in final test |
| 2 | OUT4 | Half-bridge output 4; formed by internally connected power MOS high-side switch 4 and low-side switch 4 with internal reverse diodes; short circuit protection; overtemperature protection; diagnosis for short and open load |
| 3 | VS | Power supply output stages HS4, HS5 and HS6 |
| 4 | VS | Power supply output stages HS1, HS2 and HS3 |
| 5 | OUT3 | Output 3; see pin 1 |
| 6 | OUT3 SENSE | Only for testability in final test |
| 7 | NC | Internal bond to GND |
| 8 | OUT2 | Output 2; see pin 1 |
| 9 | OUT2 SENSE | Only for testability in final test |
| 10 | OUT1 SENSE | Only for testability in final test |
| 11 | OUT1 | Output 1; see pin 1 |
| 12 | INH | Inhibit input; 5V logic input with internal pull down; low = standby, high = normal operation |



Table 2-1. Pin Description QFN24 (Continued)

| Pin | Symbol | Function |
|-----|---------------|---|
| 13 | DO | Serial data output; 5V CMOS logic level tri-state output for output (status) register data; sends 16-bit status information to the microcontroller (LSB is transferred first). Output will remain tri-stated unless device is selected by CS = low, therefore, several ICs can operate on one data output line only |
| 14 | VCC | Logic supply voltage (5V) |
| 15 | NC | Internal bond to GND |
| 16 | GND SENSE | Ground; reference potential; internal connection to the lead frame; cooling tab |
| 17 | CS | Chip select input; 5V CMOS logic level input with internal pull up; low = serial communication is enabled, high = disabled |
| 18 | CLK | Serial clock input; 5V CMOS logic level input with internal pull down; controls serial data input interface and internal shift register (f _{max} = 2MHz) |
| 19 | DI | Serial data input; 5V CMOS logic level input with internal pull down; receives serial data from the control device; DI expects a 16-bit control word with LSB being transferred first |
| 20 | OUT6 | Output 6; see pin 1 |
| 21 | OUT6 SENSE | Only for testability in final test |
| 22 | OUT5 SENSE | Only for testability in final test |
| 23 | OUT5 | Output 5; see pin 1 |
| 24 | NC | Internal bond to GND |

3. Functional Description

3.1 Serial Interface

Data transfer starts with the falling edge of the CS signal. Data must appear at DI synchronized to CLK and is accepted on the falling edge of the CLK signal. LSB (bit 0, SRR) has to be transferred first. Execution of new input data is enabled on the rising edge of the CS signal. When CS is high, pin DO is in a tri-state condition. This output is enabled on the falling edge of CS. Output data will change their state with the rising edge of CLK and stay stable until the next rising edge of CLK appears. LSB (bit 0, TP) is transferred first.

Figure 3-1. Data Transfer Input Data Protocol

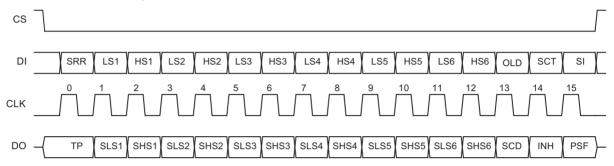


Table 3-1. Input Data Protocol

| Bit | Input Register | Function |
|-----|----------------|--|
| 0 | SRR | Status register reset (high = reset; the bits PSF, SCD and overtemperature shutdown in the output data register are set to low) |
| 1 | LS1 | Controls output LS1 (high = switch output LS1 on) |
| 2 | HS1 | Controls output HS1 (high = switch output HS1 on) |
| 3 | LS2 | See LS1 |
| 4 | HS2 | See HS1 |
| 5 | LS3 | See LS1 |
| 6 | HS3 | See HS1 |
| 7 | LS4 | See LS1 |
| 8 | HS4 | See HS1 |
| 9 | LS5 | See LS1 |
| 10 | HS5 | See HS1 |
| 11 | LS6 | See LS1 |
| 12 | HS6 | See HS1 |
| 13 | OLD | Open load detection (low = on) |
| 14 | SCT | Programmable time delay for short circuit (shutdown delay high/low = 12ms/1.5ms) |
| 15 | SI | Software inhibit; low = standby, high = normal operation (data transfer is not affected by standby function because the digital part is still powered) |



Table 3-2. Output Data Protocol

| Normal operation: high = output is on, low = output is off Open-load detection: high = open load, low = no open load (correct load condition is detected if the corresponding output is switched or 3 | Bit | Output (Status) Register | Function |
|--|-----|--------------------------|---|
| 1 Status LS1 Open-load detection: high = open load, low = no open load (correct load condition is detected if the corresponding output is switched or Normal operation: high = output is on, low = output is off Open-load detection: high = open load, low = no open load (correct load condition is detected if the corresponding output is switched or 3 Status LS2 Description see LS1 4 Status HS2 Description see HS1 5 Status LS3 Description see HS1 6 Status HS3 Description see HS1 7 Status LS4 Description see HS1 8 Status HS4 Description see HS1 9 Status LS5 Description see HS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition | 0 | TP | · · · · · · · · · · · · · · · · · · · |
| 2 Status HS1 Open-load detection: high = open load, low = no open load (correct load condition is detected if the corresponding output is switched or 3 Status LS2 Description see LS1 4 Status HS2 Description see HS1 5 Status LS3 Description see LS1 6 Status HS3 Description see HS1 7 Status LS4 Description see LS1 8 Status HS4 Description see HS1 9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition | 1 | Status LS1 | · · · · · · · · · · · · · · · · · · · |
| 4 Status HS2 Description see HS1 5 Status LS3 Description see LS1 6 Status HS3 Description see HS1 7 Status LS4 Description see LS1 8 Status HS4 Description see HS1 9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition | 2 | Status HS1 | |
| 5 Status LS3 Description see LS1 6 Status HS3 Description see HS1 7 Status LS4 Description see LS1 8 Status HS4 Description see HS1 9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition Inhibit: this bit is controlled by software (bit SI in input register) and hardware | 3 | Status LS2 | Description see LS1 |
| 6 Status HS3 Description see HS1 7 Status LS4 Description see LS1 8 Status HS4 Description see HS1 9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition Inhibit: this bit is controlled by software (bit SI in input register) and hardware the status HS6 of the short circuit detected is software (bit SI in input register) and hardware the status HS6 of the short circuit condition in the short circuit circuit circuit condi | 4 | Status HS2 | Description see HS1 |
| 7 Status LS4 Description see LS1 8 Status HS4 Description see HS1 9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition Inhibit: this bit is controlled by software (bit SI in input register) and hardward in the status LS6 in input register) and hardward in the status LS6 in input register in the status LS6 | 5 | Status LS3 | Description see LS1 |
| 8 Status HS4 Description see HS1 9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition Inhibit: this bit is controlled by software (bit SI in input register) and hardware | 6 | Status HS3 | Description see HS1 |
| 9 Status LS5 Description see LS1 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition 14 INIL Inhibit: this bit is controlled by software (bit SI in input register) and hardware | 7 | Status LS4 | Description see LS1 |
| 10 Status HS5 Description see HS1 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition Inhibit: this bit is controlled by software (bit SI in input register) and hardware the status of the status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition | 8 | Status HS4 | Description see HS1 |
| 11 Status LS6 Description see LS1 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition 14 INIL Inhibit: this bit is controlled by software (bit SI in input register) and hardware (bit SI in input register). | 9 | Status LS5 | Description see LS1 |
| 12 Status HS6 Description see HS1 13 SCD Short circuit detected: set high, when at least one output is switched off by short circuit condition Inhibit: this bit is controlled by software (bit SI in input register) and hardware. | 10 | Status HS5 | Description see HS1 |
| Short circuit detected: set high, when at least one output is switched off by short circuit condition Inhibit: this bit is controlled by software (bit SI in input register) and hardware | 11 | Status LS6 | Description see LS1 |
| short circuit condition Inhibit: this bit is controlled by software (bit SI in input register) and hardware | 12 | Status HS6 | Description see HS1 |
| | 13 | SCD | Short circuit detected: set high, when at least one output is switched off by a short circuit condition |
| initibit (piri IND). Tight – standby, low – normal operation | 14 | INH | Inhibit: this bit is controlled by software (bit SI in input register) and hardware inhibit (pin INH). High = standby, low = normal operation |
| 15 PSF Power supply fail: undervoltage at pin VS detected | 15 | PSF | Power supply fail: undervoltage at pin VS detected |

Note: Bit 0 to 15 = high: overtemperature shutdown

Table 3-3. Status of the Input Register After Power on Reset

| Bit 15 | Bit 14 | Bit 13 | Bit 12 | Bit 11 | Bit 10 | Bit 9 | Bit 8 | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 |
|--------|--------|--------|--------|--------|--------|-------|-------|-------|-------|-------|-------|-------|-------|-------|-------|
| (SI) | (SCT) | (OLD) | (HS6) | (LS6) | (HS5) | (LS5) | (HS4) | (LS4) | (HS3) | (LS3) | (HS2) | (LS2) | (HS1) | (LS1) | (SRR) |
| Н | Н | Н | L | L | L | L | L | L | L | L | L | L | L | L | L |

3.2 **Power-supply Fail**

In case of undervoltage at pin VS, an internal timer is started. When during a permanent undervoltage the delay time (t_{dLIV}) is reached, the power supply fail bit (PSF) in the output register is set and all outputs are disabled. When normal voltage is present again, the outputs are enabled immediately. The PSF bit remains high until it is reset by the SRR bit in the input reaister.

3.3 **Open-load Detection**

If the open-load detection bit (OLD) is set to low, a pull-up current for each high-side switch and a pull-down current for each low-side switch is turned on (open-load detection current I_{HS1-6} , I_{LS1-6}). If $V_{VS} - V_{HS1-6}$ or V_{LS1-6} is lower than the open-load detection threshold (open-load condition), the corresponding bit of the output in the output register is set to high. Switching on an output stage with OLD bit set to low disables the open load function for this output.

3.4 **Overtemperature Protection**

If the junction temperature exceeds the thermal prewarning threshold, T_{iPW} set, the temperature prewarning bit (TP) in the output register is set. When the temperature falls below the thermal prewarning threshold, T_{iPW} reset, the bit TP is reset. The TP bit can be read without transferring a complete 16-bit data word: with CS = high to low, the state of TP appears at pin DO. After the microcontroller has read this information, CS is set high and the data transfer is interrupted without affecting the state of the input and output registers.

If the junction temperature exceeds the thermal shutdown threshold, T_{i switch off}, the outputs are disabled and all bits in the output register are set high. The outputs can be enabled again when the temperature falls below the thermal shutdown threshold, T_{i switch on}, and when a high has been written to the SRR bit in the input register. Thermal prewarning and shutdown threshold have hysteresis.

3.5 **Short-circuit Protection**

The output currents are limited by a current regulator. Current limitation takes place when the overcurrent limitation and shutdown threshold (I_{HS1-6}, I_{LS1-6}) are reached. Simultaneously, an internal timer is started. The shorted output is disabled when during a permanent short the delay time (t_{dSd}) programmed by the short-circuit timer bit (SCT) is reached. Additionally, the short-circuit detection bit (SCD) is set. If the temperature prewarning bit TP in the output register is set during a short, the shorted output is disabled after t_{dSd} and SCD bit is set. By writing a high to the SRR bit in the input register, the SCD bit is reset and the disabled outputs are enabled.

3.6 Inhibit

There are two ways to inhibit the Atmel® ATA6838C:

- Set bit SI in the input register to 0
- Switch pin INH to 0V

In both cases, all output stages are turned off but the serial interface stays active. The output stages can be activated again by bit SI = 1 (when INH = VCC) or by pin INH switched back to VCC (when SI = 1).



4. Absolute Maximum Ratings

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

All values refer to GND pins.

| Parameters | Pin QFN24 | Symbol | Value | Unit |
|--|---------------------|--|---|------|
| Supply voltage | 3, 4 | V _{VS} | -0.3 to +40 | V |
| Supply voltage t < 0.5s; I _S > –2A | 3, 4 | V _{VS} | -1 | V |
| Supply voltage difference $V_{S_pin5(3)} - V_{S_pin10(4)}$ | 3, 4 | ΔV_{VS} | 150 | mV |
| Logic supply voltage | 14 | V _{VCC} | -0.3 to +7 | V |
| Logic input voltage | 17-19 | $V_{DI,}V_{CLK,}V_{CS}$ | -0.3 to V _{VCC} +0.3 | V |
| Logic output voltage | 13 | V_{DO} | -0.3 to V _{VCC} +0.3 | V |
| Input current | 12, 17-19 | I _{INH,} I _{DI,} I _{CLK,} I _{CS} | -10 to +10 | mA |
| Output current | 13 | I _{DO} | -10 to +10 | mA |
| Output current | 2, 5, 8, 11, 20, 23 | I _{OUT1} to I _{OUT6} | Internally limited, see "Output Specification" in Section 7. "Electrical Characteristics" on page 9 | |
| Output voltage | 2, 5, 8, 11, 20, 23 | OUT1 to OUT6 | -0.3 to +40 | V |
| Junction temperature range | | T _j | -40 to +150 | °C |
| Storage temperature range | | T _{STG} | -55 to +150 | °C |

5. Thermal Resistance

Table 5-1. QFN24: Depends on the PCB-board

| Parameter | Test Conditions | Pin | Symbol | Min. | Тур. | Max. | Unit |
|------------------|-----------------|-----|-------------------|------|------|------|------|
| Junction pin | | 16 | R _{thJP} | | | < 5 | K/W |
| Junction ambient | | | R _{thJA} | | | 35 | K/W |

6. Operating Range

| Parameter | Test Conditions | Pin QFN24 | Symbol | Min. | Тур. | Max. | Unit |
|----------------------------------|-----------------|-----------|---|----------------|------|-----------|------|
| Supply voltage | | 3, 4 | V_{VS} | $V_{UV}^{(1)}$ | | 40 | V |
| Logic supply voltage | | 14 | V_{VCC} | 4.75 | | 5.25 | V |
| Logic input voltage | | 12, 17-19 | $V_{\text{INH,}} V_{\text{DI,}} \\ V_{\text{CLK,}} V_{\text{CS}}$ | -0.3 | | V_{VCC} | V |
| Serial interface clock frequency | | | f _{CLK} | | | 2 | MHz |
| Junction temperature range | | | T _j | -40 | | +150 | °C |

7. Electrical Characteristics

 $7.5 \text{V} < \text{V}_{\text{S}} < 40 \text{V}; \ 4.75 < \text{V}_{\text{CC}} < 5.25 \text{V}; \ \text{INH} = \text{High}; -40 ^{\circ}\text{C} < \text{T}_{j} < 150 ^{\circ}\text{C}; \ \text{unless otherwise specified, all values refer to GND pins.}$

| No. | Parameters | Test Conditions | Pin QFN24 | Symbol | Min. | Тур. | Max. | Unit | Type* |
|-----|--|--|-----------|------------------|------|------|------|------|-------|
| 1 | Current Consumption | | | | | | ' | | |
| 1.1 | Total quiescent current (V _S and all outputs to VS) | $\begin{array}{l} V_S = 33V \\ V_{CC} = 0V \text{ or} \\ V_{CC} = 5V, \text{ bit SI = low or} \\ V_{CC} = 5V, \text{ pin INH = low} \\ \text{Output pins to VS and} \\ \text{GND} \end{array}$ | 3, 4 | l _{vs} | | | 2 | μА | А |
| | Quiescent current | $4.75V < V_{VCC} < 5.25V$, INH or bit SI = low | 14 | I_{VCC} | | | 20 | μA | Α |
| 1.2 | 1.2 Quiescent current (VCC) | $4.75V < V_{VCC} < 5.25V$, INH or bit SI = low, $T_J = -40^{\circ}C$ | 14 | I _{VCC} | | | 30 | μА | A |
| 1.3 | Supply current (VS) | V _{VS} < 28V normal operation, all output stages off | 3, 4 | I _{VS} | | 0.8 | 1.2 | mA | A |
| 1.4 | Supply current (VS) | V _{VS} < 28V normal operation, all output low stages on, no load | 3, 4 | I _{VS} | | | 10 | mA | A |
| 1.5 | Supply current (VS) | V _{VS} < 28V normal operation, all output high stages on, no load | 3, 4 | I _{VS} | | | 16 | mA | A |
| 1.6 | Supply current (VCC) | 4.75V < V _{VCC} < 5.25V, normal operation | 14 | I _{VCC} | | | 150 | μA | Α |
| 1.7 | Discharge current (VS) | V _{VS} = 40V, INH = low | 3, 4 | I _{VS} | | | 5 | mA | Α |
| 2 | Internal Oscillator Frequ | ency | | | | | | | |
| 2.1 | Frequency (time base for delay timers) | | | f _{OSC} | 24.3 | | 59 | kHz | Α |

^{*)} Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Note: 1. Delay time between rising edge of input signal at pin CS after data transmission and switch on/off output stages to 90% of final level. Device not in standby for t > 1ms.



7. Electrical Characteristics (Continued)

 $7.5 \text{V} < \text{V}_{\text{S}} < 40 \text{V}; 4.75 < \text{V}_{\text{CC}} < 5.25 \text{V}; \text{INH} = \text{High}; -40 ^{\circ}\text{C} < \text{T}_{\text{j}} < 150 ^{\circ}\text{C}; \text{unless otherwise specified, all values refer to GND pins.}$

| No. | Parameters | Test Conditions | Pin QFN24 | Symbol | Min. | Тур. | Max. | Unit | Type* |
|-----|---|---|------------------------|---|------------|------|------|------|-------|
| 3 | Undervoltage Detection, | | | | | | | | |
| 3.1 | Power-on reset threshold | | 14 | V_{VCC} | 2.3 | 2.7 | 3.0 | V | Α |
| 3.2 | Power-on reset delay time | After switching on V _{VCC} | | t _{dPor} | 30 | 95 | 160 | μs | А |
| 3.3 | Undervoltage detection threshold | | 14 | V _{UV} | 5.5 | | 7.0 | V | Α |
| 3.4 | Undervoltage detection hysteresis | | 14 | ΔV_{UV} | | 0.4 | | V | Α |
| 3.5 | Undervoltage detection delay | | | t_{dUV} | 4.95 | | 20 | ms | Α |
| 4 | Thermal Prewarning and | l Shutdown | | | | | | | |
| 4.1 | Thermal prewarning | | | T_{jPWset} | 120 | 145 | 170 | °C | В |
| 4.2 | Thermal prewarning | | | $T_{jPWreset}$ | 105 | 130 | 155 | °C | В |
| 4.3 | Thermal prewarning hysteresis | | | T_{jPW} | | 15 | | K | С |
| 4.4 | Thermal shutdown | | | T _{j switch off} | 150 | 175 | 200 | °C | В |
| 4.5 | Thermal shutdown | | | T _{j switch on} | 135 | 160 | 185 | °C | В |
| 4.6 | Thermal shutdown hysteresis | | | T _{j switch off} | | 15 | | К | С |
| 4.7 | Ratio thermal shutdown/thermal prewarning | | | T _{j switch off/} | 1.05 | 1.2 | | | С |
| 4.8 | Ratio thermal shutdown/thermal prewarning | | | T _{j switch on/} T _{jPW reset} | 1.05 | 1.2 | | | С |
| 5 | Output Specification (LS | 1-LS6, HS1-HS6) 7.5V < | V _{VS} < 40V | | | | | | |
| 5.1 | On resistance | I _{Out} = 600mA | 2, 5, 8, 11, 20, 23 | R _{DS OnL} | | | 1.8 | Ω | Α |
| 5.2 | On resistance | I _{Out} = -600mA | 2, 5, 8, 11, 20, 23 | $R_{DS\ OnH}$ | | | 1.8 | Ω | Α |
| 5.3 | High-side output leakage current (total quiescent current see 1.1) | V _{Out1-6} = 0V all output stages off | 2, 5, 8, 11, 20, 23 | I _{Out1-6} | –15 | | | μА | A |
| 5.4 | Low-side output leakage current (total quiescent current see 1.1) | V _{Out1-6} = VS all output stages off | 2, 5, 8, 11, 20, 23 | I _{Out1-6} | | | 120 | μА | A |
| 5.5 | Inductive shutdown energy | | 2, 5, 8, 11, 20, 23 | W _{outx} | | | 15 | mJ | D |
| 5.6 | Overcurrent limitation and shutdown threshold | V _{VS} = 13V | 2, 5, 8, 11, 20, 23 | I _{LS1-6} | 950 | 1250 | 1710 | mA | Α |

^{*)} Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

Note: 1. Delay time between rising edge of input signal at pin CS after data transmission and switch on/off output stages to 90% of final level. Device not in standby for t > 1ms.



Electrical Characteristics (Continued) 7.

 $7.5 \text{V} < \text{V}_{\text{S}} < 40 \text{V}; 4.75 < \text{V}_{\text{CC}} < 5.25 \text{V}; \text{INH} = \text{High}; -40 ^{\circ}\text{C} < \text{T}_{\text{j}} < 150 ^{\circ}\text{C}; \text{unless otherwise specified, all values refer to GND pins.}$

| 5.7 Overcurrent limitation and shutdown threshold 20V < V _{VS} < 40V 2,5 ,8 ,11, 20,23 1,151-6 950 2100 mA C C C C C C C C C | No. | Parameters | Test Conditions | Pin QFN24 | Symbol | Min. | Тур. | Max. | Unit | Type* |
|---|------|---|---|-----------|----------------------|-------|-------|------|------|-------|
| 9.8. and shutdown threshold 20V < V _{VS} < 40V | 5.7 | | V _{VS} = 13V | | I _{HS1-6} | -1710 | -1250 | -950 | mA | Α |
| 5.9. Overcurrent limitation and shutdown threshold of and shutdown threshold of and shutdown threshold believed the state of the stat | 5.8 | Overcurrent limitation and shutdown threshold | 20V < V _{VS} < 40V | | I _{LS1-6} | 950 | | 2100 | mA | С |
| 5.10 Covercument shutdown delay time Covercument Covercum | 5.9 | Overcurrent limitation | | | I _{HS1-6} | -2100 | | -950 | mA | С |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | 5.10 | | bit 14 (SCT) = low | | t _{dSd} | 0.45 | 1.3 | 2.1 | ms | А |
| 3-12 detection current (OLD) = low, output off 20, 23 lout1-6H -1.5 -0.4 IIIA A | 5.11 | | bit 14 (SCT) = High | | t _{dSd} | 4.8 | 9 | 15 | ms | А |
| 3.13 detection current (OLD) = low, output off 20, 23 lout1-6L 0.45 1.75 IIIA A | 5.12 | | | | I _{Out1-6H} | -1.5 | | -0.4 | mA | Α |
| $\begin{array}{c ccccccccccccccccccccccccccccccccccc$ | 5.13 | | | | I _{Out1-6L} | 0.45 | | 1.75 | mA | Α |
| 5.15 detection voltage (OLD) = low, output off 20, 23 Vout1-6H 0.6 2.5 V A 5.16 Low-side open load detection voltage (OLD) = low, output off 25, 58, 11, 20, 23 Vout1-6L 0.7 2.1 V A 5.17 High-side output switch on delay ⁽¹⁾ $V_{VS} = 13V$ $V_{Load} = 30\Omega$ $V_{VS} = 13V$ $V_{Load} = 30\Omega$ $V_{Load} = 30\Omega$ $V_{VS} = 13V$ $V_{Load} = 30\Omega$ $V_{Load} =$ | 5.14 | | | | | 1.05 | 1.2 | 2 | | |
| detection voltage $(OLD) = low, output off$ $20, 23$ $V_{Out1-6L}$ 0.7 2.1 V A 0.7 | 5.15 | | | | V _{Out1-6H} | 0.6 | | 2.5 | V | Α |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | 5.16 | | | | V _{Out1-6L} | 0.7 | | 2.1 | V | Α |
| $\begin{array}{cccccccccccccccccccccccccccccccccccc$ | 5.17 | High-side output switch on delay ⁽¹⁾ | | | t _{don} | | | 20 | μs | Α |
| $ \begin{array}{c ccccccccccccccccccccccccccccccccccc$ | 5.18 | | | | t _{don} | | | 20 | μs | Α |
| 5.20 off delay ⁽¹⁾ $R_{Load} = 30\Omega$ V_{doff} V_{doff} V_{Load} | 5.19 | | | | t _{doff} | | | 20 | μs | Α |
| 5.21 corresponding high- and low-side switches $R_{Load} = 30\Omega$ R_{Load} | 5.20 | Low-side output switch off delay ⁽¹⁾ | $V_{VS} = 13V$ $R_{Load} = 30\Omega$ | | t_{doff} | | | 3 | μs | Α |
| 6.1 Input voltage low-level threshold 12 V _{IL} 0.3 × V _{VCC} V A 6.2 Input voltage high-level threshold 12 V _{IH} 0.3 × V _{VCC} V A 13 V _{IH} 0.3 × V _{VCC} V A | 5.21 | corresponding high- and | $V_{VS} = 13V$ $R_{Load} = 30\Omega$ | | $t_{don} - t_{doff}$ | 0.7 | | | μs | A |
| 6.1 threshold 6.2 Input voltage high-level threshold 12 V _{IL} V _{VCC} V A 12 V _{IL} V _{VCC} 12 V _{IH} 13 V _{IH} 14 V _{VCC} V A 15 AV 100 700 mV A | 6 | Inhibit Input | | | | | | | | |
| threshold V _{IH} V _{VCC} V A Hysteresis of input 12 AV 100 700 mV A | 6.1 | | | 12 | V _{IL} | | | | V | А |
| | 6.2 | | | 12 | V _{IH} | | | | V | А |
| Totago | 6.3 | Hysteresis of input voltage | | 12 | ΔV_{I} | 100 | | 700 | mV | А |
| 6.4 Pull-down current $V_{INH} = V_{VCC}$ I_{PD} 10 80 μ A A | 6.4 | Pull-down current | V _{INH} = V _{VCC} | | I _{PD} | 10 | | 80 | μA | Α |

^{*)} Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

1. Delay time between rising edge of input signal at pin CS after data transmission and switch on/off output stages to 90% Note: of final level. Device not in standby for t > 1ms.



7. Electrical Characteristics (Continued)

 $7.5 \text{V} < \text{V}_{\text{S}} < 40 \text{V}; 4.75 < \text{V}_{\text{CC}} < 5.25 \text{V}; \text{INH} = \text{High}; -40 ^{\circ}\text{C} < \text{T}_{\text{j}} < 150 ^{\circ}\text{C}; \text{unless otherwise specified, all values refer to GND pins.}$

| No. | Parameters | Test Conditions | Pin QFN24 | Symbol | Min. | Тур. | Max. | Unit | Type* |
|-----|------------------------------------|---|-----------|-------------------|-------------------------|------|---------------------------|------|-------|
| 7 | Serial Interface: Logic In | puts DI, CLK, CS | | | | | | | |
| 7.1 | Input voltage low-level threshold | | 17-19 | $V_{\rm IL}$ | $0.3 \times V_{VCC}$ | | | V | Α |
| 7.2 | Input voltage high-level threshold | | 17-19 | V _{IH} | | | 0.7 × V _{VCC} | V | Α |
| 7.3 | Hysteresis of input voltage | | 17-19 | ΔV_{I} | 50 | | 500 | mV | Α |
| 7.4 | Pull-down current pin DI, CLK | V_{DI} , $V_{CLK} = V_{VCC}$ | 18, 19 | I _{PDSI} | 2 | | 50 | μA | Α |
| 7.5 | Pull-up current pin CS | V _{CS} = 0V | 17 | I _{PUSI} | -50 | | -2 | μA | Α |
| 8 | Serial Interface: Logic O | utput DO | | | | | | | |
| 8.1 | Output voltage low level | I _{OL} = 3mA | 13 | V_{DOL} | | | 0.5 | V | Α |
| 8.2 | Output voltage high level | I _{OL} = -1mA | 13 | V_{DOH} | V _{VCC} – 0.7V | | | V | Α |
| 8.3 | Leakage current (tri-state) | $V_{CS} = V_{VCC}$, $0V < V_{DO} < V_{VCC}$ | 13 | I _{DO} | -10 | | 10 | μА | Α |

^{*)} Type means: A = 100% tested, B = 100% correlation tested, C = Characterized on samples, D = Design parameter

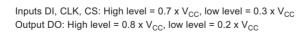
Note: 1. Delay time between rising edge of input signal at pin CS after data transmission and switch on/off output stages to 90% of final level. Device not in standby for t > 1ms.

8. Serial Interface: Timing

| Parameters | Test Conditions | QFN24 | Number in Timing Diagram (Figure 8-1 on page 13) | Symbol | Min. | Тур. | Max. | Unit |
|---------------------------------|------------------------------------|-------|--|-----------------------|------|------|------|------|
| DO enable after CS falling edge | C _{DO} = 100pF | 13 | 1 | t _{ENDO} | | | 200 | ns |
| DO disable after CS rising edge | C _{DO} = 100pF | 13 | 2 | t _{DISDO} | | | 200 | ns |
| DO fall time | C _{DO} = 100pF | 13 | - | t _{DOf} | | | 100 | ns |
| DO rise time | C _{DO} = 100pF | 13 | - | t _{DOr} | | | 100 | ns |
| DO valid time | C _{DO} = 100pF | 13 | 10 | t _{DOVal} | | | 200 | ns |
| CS setup time | | 17 | 4 | t _{CSSethl} | 225 | | | ns |
| CS setup time | | 17 | 8 | t _{CSSetIh} | 225 | | | ns |
| CS high time | Input register bit 14 (SCT) = high | 17 | 9 | t _{CSh} | 17 | | | ms |
| CS high time | Input register bit 14 (SCT) = low | 17 | 9 | t _{CSh} | 2.1 | | | ms |
| CLK high time | | 18 | 5 | t _{CLKh} | 225 | | | ns |
| CLK low time | | 18 | 6 | t _{CLKI} | 225 | | | ns |
| CLK period time | | 18 | - | t _{CLKp} | 500 | | | ns |
| CLK setup time | | 18 | 7 | t _{CLKSethl} | 225 | | | ns |
| CLK setup time | | 18 | 3 | t _{CLKSetlh} | 225 | | | ns |
| DI setup time | | 19 | 11 | t _{Diset} | 40 | | | ns |
| DI hold time | | 19 | 12 | t _{DIHold} | 40 | | | ns |

CS DO CS CLK (6) DI (11) CLK (12) DO

Figure 8-1. Serial Interface Timing Diagram with Item Numbers





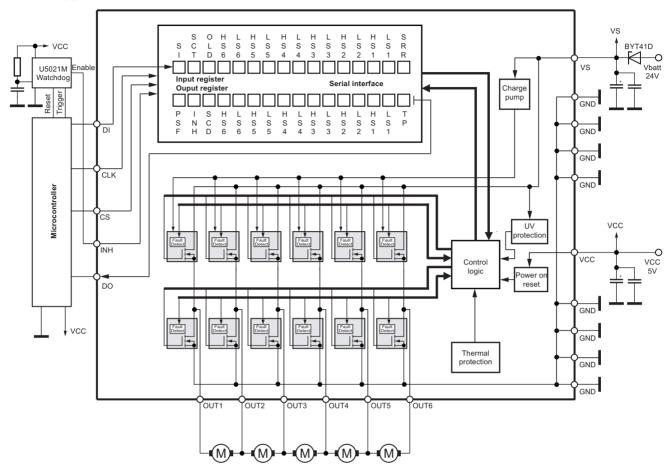
9. Noise and Surge Immunity

| Parameters | Test Conditions | Value |
|---------------------------|-----------------|--|
| Conducted interferences | ISO 7637-1 | Level 4 ⁽¹⁾ |
| Interference suppression | VDE 0879 Part 2 | Level 5 |
| ESD (Human Body Model) | ESD S 5.1 | 4kV |
| CDM (Charge Device Model) | ESD STM5.3 | 750V for corner pins (SO package only) 500V all other pins |
| MM (Machine Model) | ESD STM5.2 | 200V |

Note: 1. Test pulse 5: V_{vbmax} = 40V

10. Application Circuit

Figure 10-1. Application Circuit



10.1 Application Notes

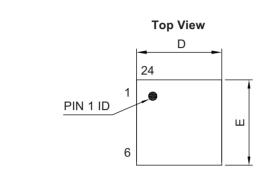
- Connect the blocking capacitors at V_{CC} and V_S as close as possible to the power supply and GND pins.
- Recommended value for capacitors at V_S:
 Electrolytic capacitor C > 22µF in parallel with a ceramic capacitor C = 100nF.
 Value for electrolytic capacitor depends on external loads, conducted interferences and reverse-conducting current IHSX (see Section 4. "Absolute Maximum Ratings" on page 8).
- Recommended value for capacitors at VCC:
 Electrolytic capacitor C > 10µF in parallel with a ceramic capacitor C = 100nF.
- To reduce thermal resistance, place cooling areas on the PCB as close as possible to GND pins and to the die paddle in QFN24.
- The sense pins OUTx SENSE can either be left open or can be connected to the adjacent OUTx pin. Never use the sense pins OUTx SENSE as power outputs.

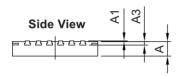


11. Ordering Information

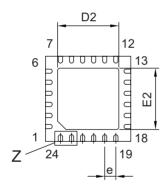
| Extended Type Number | Package | Remarks |
|----------------------|---------|-------------------------------|
| ATA6838C-PXQW-1 | QFN24 | Pb-free, 6k, taped and reeled |

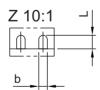
12. Package Information





Bottom View





| | СОММО | ON DIME | NSIONS | |
|--------|---------|-----------|---------|------|
| | (Unit o | f Measure | e = mm) | |
| Symbol | MIN | NOM | MAX | NOTE |
| Α | 0.8 | 0.85 | 0.9 | |
| A1 | 0.0 | 0.035 | 0.05 | |
| A3 | 0.16 | 0.21 | 0.26 | |
| D | 4.9 | 5 | 5.1 | |
| D2 | 3.5 | 3.6 | 3.7 | |
| E | 4.9 | 5 | 5.1 | · |

3.6

0.4

0.25

0.65

3.7

0.45

0.3

E2

L

b

3.5

0.35

0.2

technical drawings according to DIN specifications

Dimensions in mm

10/18/13

| Atmel | Package Drawing Contact: packagedrawings@atmel.com |
|-------|---|
| | |

| TITLE | |
|---|---|
| Package: VQFN_5x5_24 Exposed pad 3.6x3.6 | L |

| GPC | DRAWING NO. | REV. |
|-----|-----------------|------|
| | 6.543-5132.02-4 | 1 |

13. Revision History

Please note that the following page numbers referred to in this section refer to the specific revision mentioned, not to this document.

| Revision No. | History |
|------------------|--|
| 9237G-AUTO-02/15 | Section 11 "Ordering Information" on page 16 updated |
| 9237G-AUTO-02/15 | Section 12 "Package Information" on page 16 updated |
| 9237F-AUTO-05/12 | Set datasheet from "Preliminary" to "Standard" |
| 9237E-AUTO-03/12 | Section 3.5 "Short-circuit Protection" on page 7 updated |
| 9237D-AUTO-12/11 | • Section 7 "Electrical Characteristics" numbers 3.5, 5.10, 5.13 and 5.16 on page 10 to 11 updated |
| 9237C-AUTO-10/11 | Section 10.1 "Application Notes" on page 15 updated |















Atmel Corporation

1600 Technology Drive, San Jose, CA 95110 USA

T: (+1)(408) 441.0311

F: (+1)(408) 436.4200

www.atmel.com

© 2015 Atmel Corporation. / Rev.: 9237G-AUTO-02/15

Atmel®, Atmel logo and combinations thereof, Enabling Unlimited Possibilities®, and others are registered trademarks or trademarks of Atmel Corporation in U.S. and other countries. Other terms and product names may be trademarks of others.

DISCLAIMER: The information in this document is provided in connection with Atmel products. No license, express or implied, by estoppel or otherwise, to any intellectual property right is granted by this document or in connection with the sale of Atmel products. EXCEPT AS SET FORTH IN THE ATMEL TERMS AND CONDITIONS OF SALES LOCATED ON THE ATMEL WEBSITE, ATMEL ASSUMES NO LIABILITY WHATSOEVER AND DISCLAIMS ANY EXPRESS, IMPLIED OR STATUTORY WARRANTY RELATING TO ITS PRODUCTS INCLUDING, BUT NOT LIMITED TO, THE IMPLIED WARRANTY OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE, OR NON-INFRINGEMENT. IN NO EVENT SHALL ATMEL BE LIABLE FOR ANY DIRECT, INDIRECT, CONSEQUENTIAL, PUNITIVE, SPECIAL OR INCIDENTAL DAMAGES (INCLUDING, WITHOUT LIMITATION, DAMAGES FOR LOSS AND PROFITS, BUSINESS INTERRUPTION, OR LOSS OF INFORMATION) ARISING OUT OF THE USE OR INABILITY TO USE THIS DOCUMENT, EVEN IF ATMEL HAS BEEN ADVISED OF THE POSSIBILITY OF SUCH DAMAGES. Atmel makes no representations or warranties with respect to the accuracy or completeness of the contents of this document and reserves the right to make changes to specifications and products descriptions at any time without notice. Atmel does not make any commitment to update the information contained herein. Unless specifically provided otherwise, Atmel products are not suitable for, and shall not be used in, automotive applications. Atmel products are not intended, authorized, or warranted for use as components in applications intended to support or sustain life.

SAFETY-CRITICAL, MILITARY, AND AUTOMOTIVE APPLICATIONS DISCLAIMER: Atmel products are not designed for and will not be used in connection with any applications where the failure of such products would reasonably be expected to result in significant personal injury or death ("Safety-Critical Applications") without an Atmel officer's specific written consent. Safety-Critical Applications include, without limitation, life support devices and systems, equipment or systems for the operation of nuclear facilities and weapons systems. Atmel products are not designed nor intended for use in military or aerospace applications or environments unless specifically designated by Atmel as military-grade. Atmel products are not designed nor intended for use in automotive applications unless specifically designated by Atmel as automotive-grade.

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Microchip:

ATA6838C-PXQW ATA6838C-PXQW-1